

ET6H3XX - High Input Very-Low IQ 300mA LDO

General Description

ET6H3XX series are the high input very low I_Q 300mA LDO with enable function that operates from 1.8V–5V, is designed specifically for portable battery-powered applications which require ultra-low quiescent current. The very-low consumption of type 3.0 μ A ensures long battery life and dynamic transient boost feature improves device transient response for wireless communication applications.

ET6H3XX series are offered SOT89-3, SOT89-5, SOT23-5, SOT23-3, DNF4(1x1) packages

Features

- Wide input voltage range from 2.8V to 45V
- Up to 300mA Load Current
- Very low I_Q is 3.0 μ A typical
- Fixed Output Voltage are 1.8V, 2.5V, 2.8V, 3.0V, 3.3V, 3.6V, 5V, etc
- Low dropout is 1000mV at 300mA Load @ $V_{OUT}=3.3V$
- Excellent load/line transient response
- High Ripple Rejection: 70dB at 1KHz
- Packages are SOT89-3, SOT23-5, SOT23-3, DFN4 (1x1)

Device information

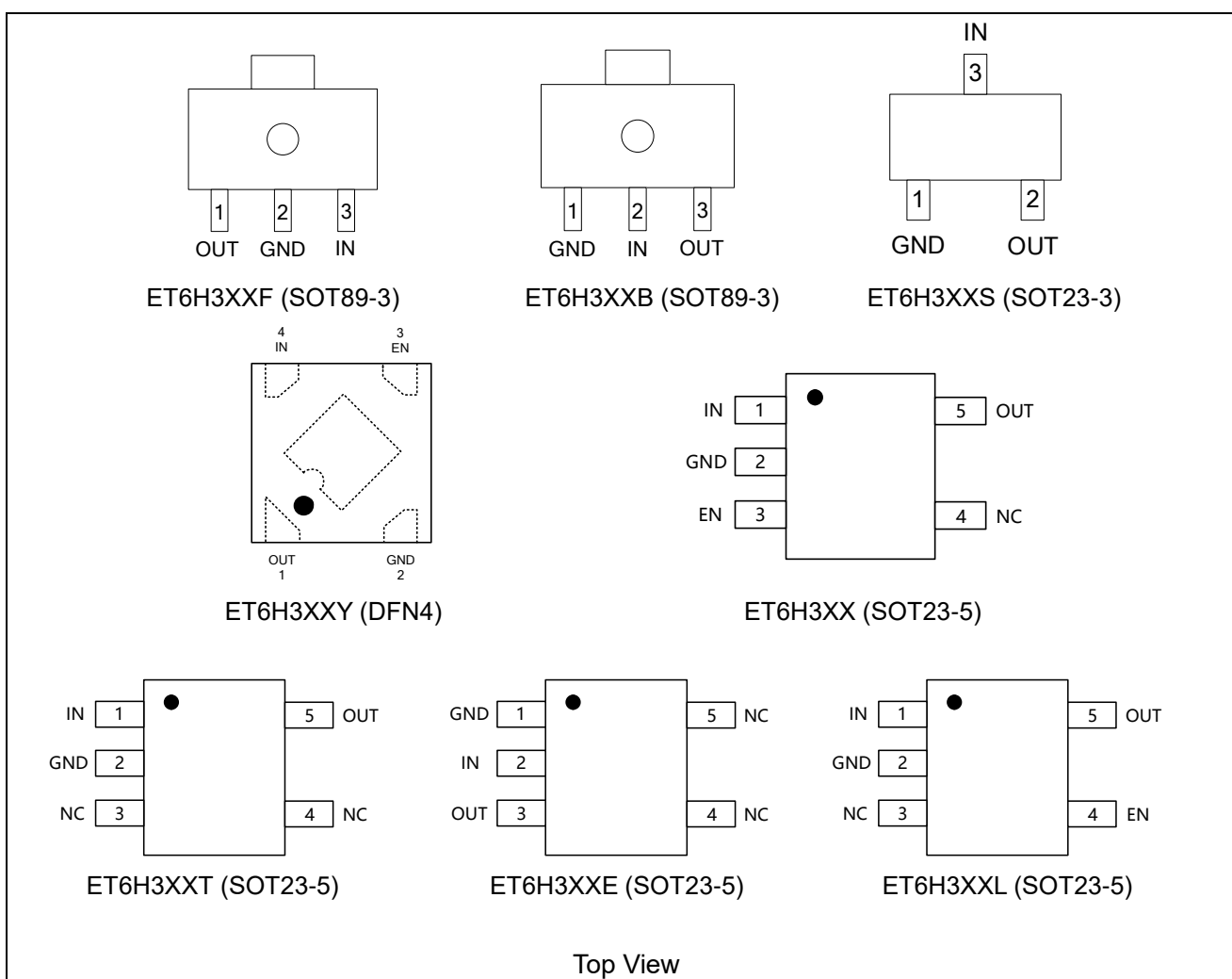
Part No.	Package	Packing Option	MSL
ET6H3XXF	SOT89-3	Tape and Reel, 1K/Reel	3
ET6H3XXB		Tape and Reel, 1K/Reel	3
ET6H3XXS	SOT23-3	Tape and Reel, 3K/Reel	3
ET6H3XXT	SOT23-5	Tape and Reel, 3K/Reel	3
ET6H3XXL		Tape and Reel, 3K/Reel	3
ET6H3XX	SOT23-5 (Default)	Tape and Reel, 3K/Reel	3
ET6H3XXY	DFN4	Tape and Reel, 10K/Reel	1

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Mark Specification Label

Part No.	Marking								V _{OUT}
	SOT89-3		SOT23-3	DFN4	SOT23-5				
	XXB	XXF	XXS	XXY	XX	XXT	XXE	XXL	
ET6H318	18B	18F	18S	CX	18	18T	18E	18L	1.8V
ET6H325	25B	25F	25S	FX	25	25T	25E	25L	2.5V
ET6H328	28B	28F	28S	DX	28	28T	28E	28L	2.8V
ET6H330	30B	30F	30S	GX	30	30T	30E	30L	3.0V
ET6H333	33B	33F	33S	EX	33	33T	33E	33L	3.3V
ET6H336	36B	36F	36S	RX	36	36T	36E	36L	3.6V
ET6H350	50B	50F	50S	ZX	50	50T	50E	50L	5.0V

Pin Configuration

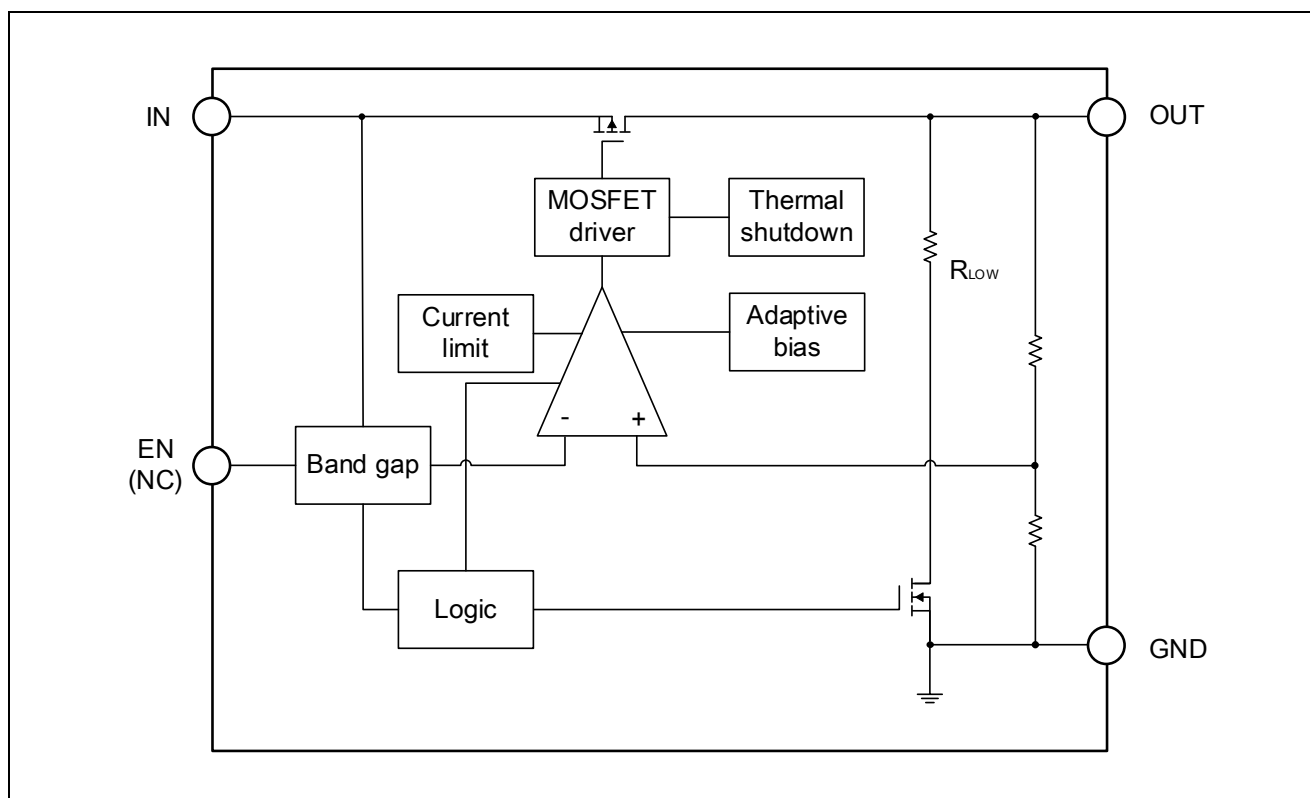


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Pin Function

Pin No.								Pin Name	Pin Function
SOT89-3		SOT23-3	DFN4	SOT23-5					
XXF	XXB	XXS	XXY	XX	XXT	XXE	XXL		
2	1	1	2	2	2	1	2	GND	Ground.
3	2	3	4	1	1	2	1	IN	Supply input pin.
1	3	2	1	5	5	3	5	OUT	Output pin.
			3	3			4	EN	Enable control input, active high.
				4	3, 4	4, 5	3	NC	No connection.

Block Diagram



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Functional Description

Input Capacitor

A 1 μ F~10 μ F ceramic capacitor is recommended to connect between VIN and GND pins to decouple input power supply glitch and noise. The amount of the capacitance may be increased without limit. This input capacitor must be located as close as possible to the device to assure input stability and less noise. For PCB layout, a wide copper trace is required for both VIN and GND.

Output Capacitor

An output capacitor is required for the stability of the LDO. The recommended output capacitance is from 1 μ F to 10 μ F, Equivalent Series Resistance (ESR) is from 5m Ω to 100m Ω , and temperature characteristics are X7R or X5R. Higher capacitance values help to improve load/line transient response. The output capacitance may be increased to keep low undershoot/overshoot. Place output capacitor as close as possible to OUT and GND pins.

Enable (If EN PIN Exist)

The ET6H3XX delivers the output power when it is set to enable state. When it works in disable state, there is no output power and the operation quiescent current is almost zero. The enable pin (EN) is active high.

Dropout Voltage

The ET6H3XX uses a PMOS pass transistor to achieve low dropout. When ($V_{IN} - V_{OUT}$) is less than the dropout voltage (VDO), the PMOS pass device is in the linear region of operation and the input-to-output resistance is the $R_{DS(ON)}$ of the PMOS pass element. VDO scales approximately with output current because the PMOS device behaves like a resistor in dropout mode. As with any linear regulator, PSRR and transient response degrade as ($V_{IN} - V_{OUT}$) approaches dropout operation.

Thermal Shutdown

Thermal shutdown protection disables the output when the junction temperature rises to approximately 155°C. Disabling the device eliminates the power dissipated by the device, allowing the device to cool. When the junction temperature cools to approximately 125°C, the output circuitry is again enabled.

Depending on power dissipation, thermal resistance, and ambient temperature, the thermal protection circuit may cycle on and off. This cycling limits regulator dissipation, protecting the LDO from damage as a result of overheating. Activating the thermal shutdown feature usually indicates excessive power dissipation as a result of the product of the ($V_{IN} - V_{OUT}$) voltage and the load current. For reliable operation, limit junction temperature to 125°C maximum.

Thermal Considerations

For continuous operation, do not exceed absolute maximum junction temperature. The maximum power dissipation depends on the thermal resistance of the IC package, PCB layout, rate of surrounding airflow, and difference between junction and ambient temperature. The maximum power dissipation can be calculated by the following formula:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$$

where $T_{J(MAX)}$ is the maximum junction temperature, T_A is the ambient temperature, and θ_{JA} is the junction to ambient thermal resistance.

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For recommended operating conditions the maximum junction temperature is 150°C and T_A is the ambient temperature. The junction to ambient thermal resistance (θ_{JA}) is layout dependent.

For SOT89-3 package, the thermal resistance (θ_{JA}) is 135°C/W on the test board. The maximum power dissipation at $T_A = 25^\circ\text{C}$ can be calculated by the following formula:

$$P_{D(MAX)} = (150^\circ\text{C} - 25^\circ\text{C}) / (135^\circ\text{C} / \text{W}) = 0.925\text{W for SOT89-3 package}$$

The maximum power dissipation depends on the operating ambient temperature for fixed $T_{J(MAX)}$ and thermal resistance (θ_{JA}). The derating curve in Figure 6 allows the designer to see the effect of rising ambient temperature on the maximum power dissipation.

Current-Limit Protection

The ET6H3XX provides current limit function to prevent the device from damages during over-load or shorted-circuit condition. This current is detected by an internal sensing transistor.

Layout Guidelines

- Place input and output capacitors as close to the device as possible.
- Use copper planes for device connections in order to optimize thermal performance.
- Place thermal vias around the device to distribute heat.
- Do not place a thermal via directly beneath the thermal pad . A via can wick solder or solder paste away from the thermal pad joint during the soldering process, leading to a compromised solder joint on the thermal pad.

Absolute Maximum Ratings

Symbol	Rating	Value	Unit
V_{IN}	Input Voltage ⁽¹⁾	-0.3~53	V
V_{OUT}	Output Voltage	-0.3~6	V
V_{EN}	Chip Enable Input (If EN PIN Exist)	-0.3~53	V
$T_{J(MAX)}$	Maximum Junction Temperature	150	°C
T_{STG}	Storage Temperature	-55~150	°C
$V_{ESD}^{(2)}$	HBM Capability	±4000	V
	CDM Capability	±1500	V
$I_{LU}^{(2)}$	Latch up Current Maximum Rating	±200	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Note1. Refer to Electrical Characteristics and Application Information for Safe Operating Area.

Note2. This device series incorporates ESD protection and is tested by the following methods:

ESD Human Body Model tested per EIA/JESD22-A114;

CDM tested per JESD22-C101;

Latch up Current Maximum Rating tested per JEDEC78.

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Thermal Characteristics

Symbol	Package	Ratings	Value	Unit
R _{θJA}	SOT89-3	Thermal Characteristics, Thermal Resistance, Junction-to-Air	135	°C/W
	SOT89-5		80	
	SOT23-5		250	
	SOT23-3		360	
	DFN4		250	
P _D	SOT89-3	Power Dissipation @25°C PCB board dimension: 40mm x 40mm (2layer) Copper :1OZ	920	mW
	SOT89-5		1500	
	SOT23-5		500	
	SOT23-3		420	
	DFN4		500	

Recommended Operating Conditions

Symbol	Item	Rating	Unit
V _{IN}	Input Voltage	2.8 to 45	V
I _{OUT}	Output Current	0 to 300	mA
T _A	Operating Ambient Temperature	-40 to 85	°C
C _{IN}	Effective Input Ceramic Capacitor Value	1 to 10	uF
C _{OUT}	Effective Output Ceramic Capacitor Value	1 to 10	uF
ESR	Input and Output Capacitor Equivalent Series Resistance (ESR)	5 to 100	mΩ

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Electrical Characteristics

($V_{IN} = V_{OUT} + 2V$; $I_{OUT} = 10mA$, $C_{IN} = C_{OUT} = 1.0\mu F$, unless otherwise noted. Typical values are at $T_A = +25^\circ C$.)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
V_{IN}	Operating Input Voltage ⁽³⁾		2.8		45	V
V_{OUT}	Output Voltage	$T_A = +25^\circ C$	-2%		+2%	V
		$-40^\circ C \leq T_A \leq 85^\circ C$	-3%		+3%	
I_Q	Quiescent Current	$I_{OUT} = 0mA$		3	6	μA
I_{Q_OFF}	Standby Current	$V_{EN} = 0V$, $T_A = 25^\circ C$		0.1	1	μA
$Line_{REG}$	Line Regulation	$V_{IN} = V_{OUT} + 1V$ to $45V$, $I_{OUT} = 10mA$ ($\Delta V_{OUT} / \Delta V_{IN} / V_{OUT}$)		0.05	0.20	%/V
V_{DROP}	Dropout Voltage $I_{OUT} = 300mA$ ⁽⁴⁾	$V_{OUT} = 1.8V$		1350	1650	mV
		$V_{OUT} = 2.5V$		1150	1450	
		$V_{OUT} = 2.8V$		1100	1400	
		$V_{OUT} = 3.0V$		1050	1350	
		$V_{OUT} = 3.3V$		1000	1300	
		$V_{OUT} = 3.6V$		950	1250	
		$V_{OUT} = 5V$		900	1200	
$Load_{REG}$	Load Regulation	$1mA \leq I_{OUT} \leq 300mA$, $V_{IN} = V_{OUT} + 2V$			40	mV
I_{LMT}	Current Limit	$V_{IN} = V_{OUT} + 2V$	350	650		mA
I_{SC}	Short Current Limit	$V_{IN} = V_{OUT} + 2V$		130		mA
V_{ENH}	EN Pin Threshold Voltage (If EN PIN Exist)	EN Input Voltage "H"	1.2			V
V_{ENL}	EN Pin Threshold Voltage (If EN PIN Exist)	EN Input Voltage "L"			0.4	V
I_{EN}	EN Pin Current (If EN PIN Exist)	$V_{EN} = 0 \sim 45V$		1		μA
PSRR	Power Supply Rejection Ratio ⁽⁵⁾	$f = 1kHz$, $V_{IN} = V_{OUT} + 1V$ $I_{OUT} = 20mA$		70		dB
e_N	Output Noise Voltage ⁽⁵⁾	$V_{IN} = V_{OUT} + 2V$, $I_{OUT} = 1mA$, $f = 10Hz$ to $100KHz$, $V_{OUT} = 3.3V$, $C_{OUT} = 1\mu F$		150		μV_{rms}
T_{SD}	Thermal Shutdown Temperature ⁽⁵⁾	Temperature Increasing from $T_A = +25^\circ C$		155		$^\circ C$
T_{SDH}	Thermal Shutdown Hysteresis ⁽⁵⁾	Temperature Falling from TSD		30		$^\circ C$

Note3. Here V_{IN} means internal circuit can work normal. If $V_{IN} < V_{OUT}$, Output voltage follows V_{IN} ($I_{OUT} = 1mA$), circuit is safety.

Note4. V_{DROP} FT test method: test the V_{OUT} voltage at $V_{SET} + V_{DROP_{MAX}}$ with 300mA output current.

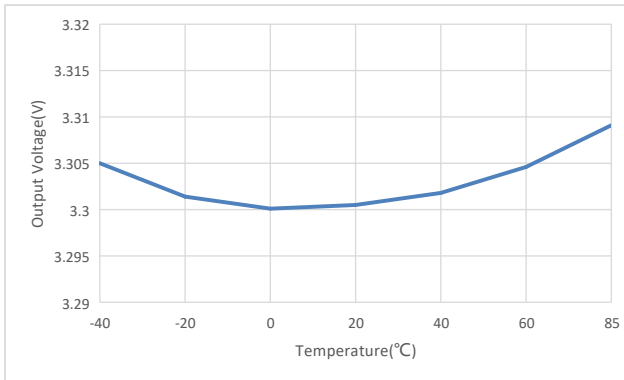
Note5. Guaranteed by design and characterization. not a FT item.

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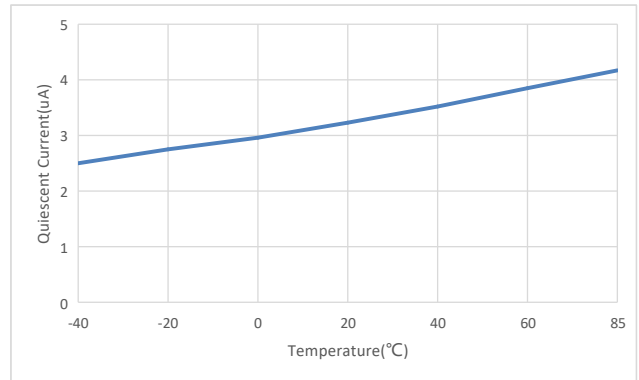
Typical Characteristics

VOLTAGE VERSION 3.3V

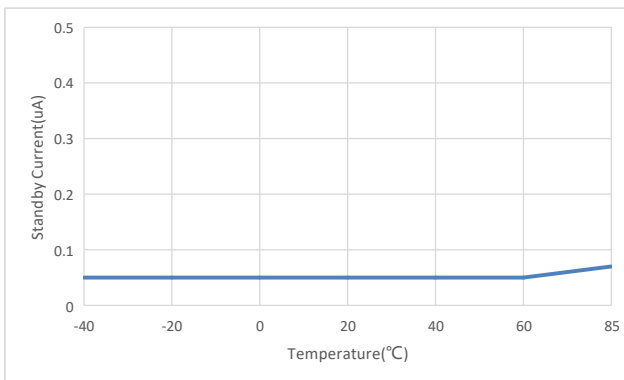
($V_{IN} = V_{OUT} + 2V$; $I_{OUT} = 10mA$, $C_{IN} = C_{OUT} = 1.0\mu F$, unless otherwise noted. Typical values are at $T_A = +25^\circ C$.)



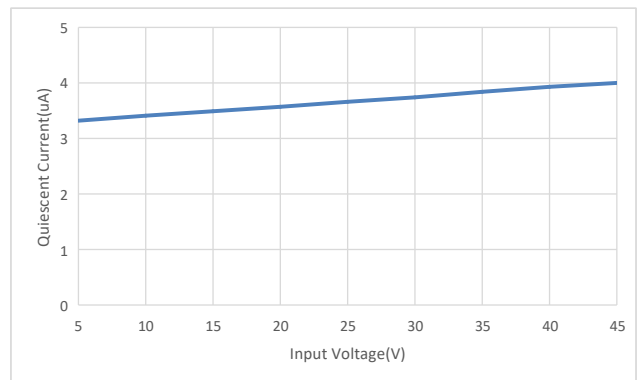
Output Voltage VS Temperature



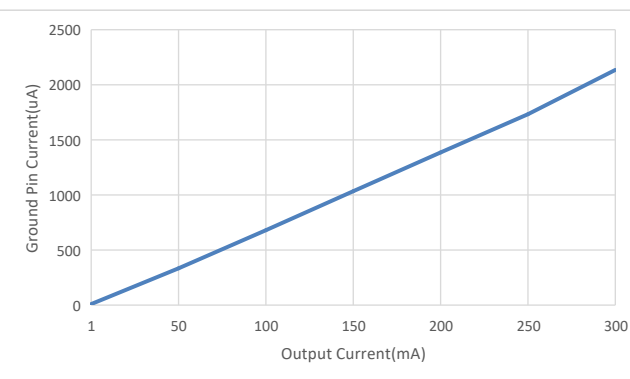
Quiescent Current VS Temperature



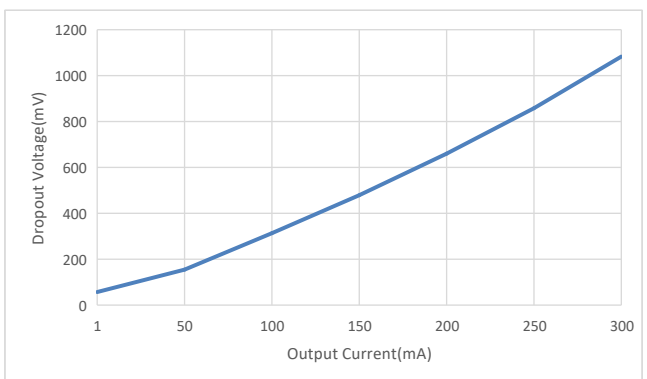
Standby Current VS Temperature



Quiescent Current VS Input Voltage

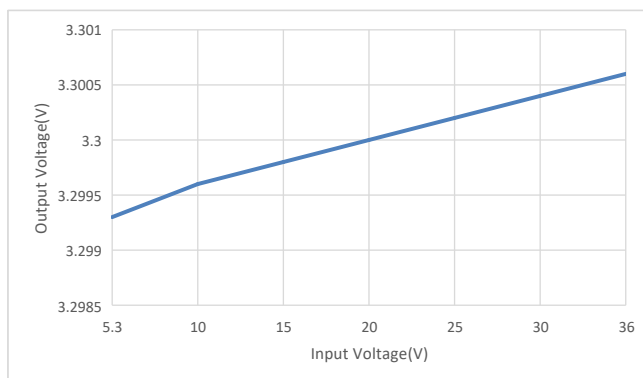


Ground Pin Current VS Output Current

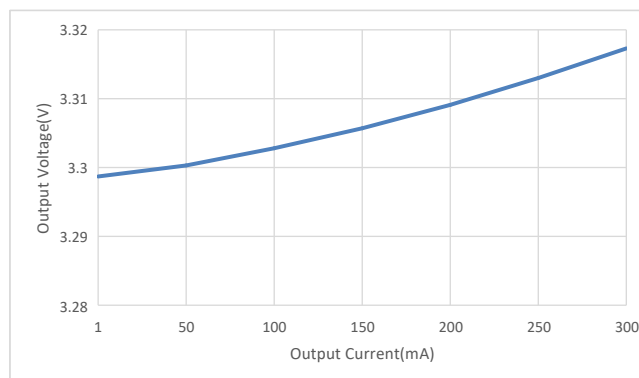


Dropout Voltage VS Output Current

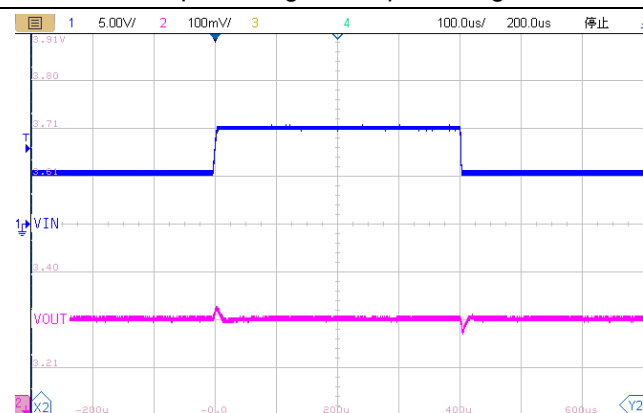
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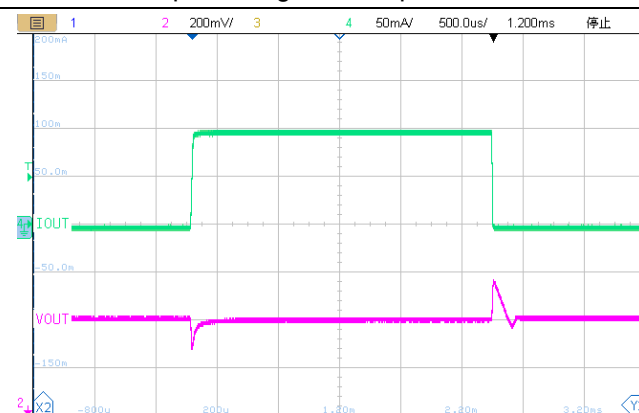
Output Voltage VS Input Voltage



Output Voltage VS Output Current



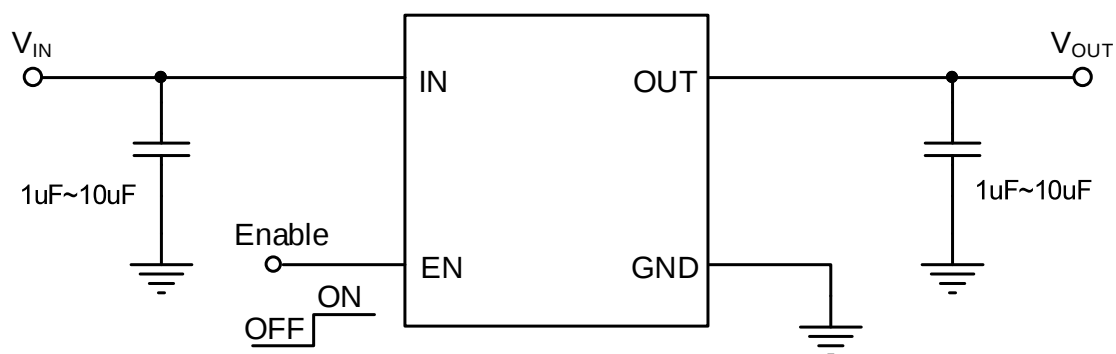
Line Transient Response
 $V_{IN}=5.3V\sim 10V$, $V_{OUT}=3.3V$, $I_{OUT}=10mA$



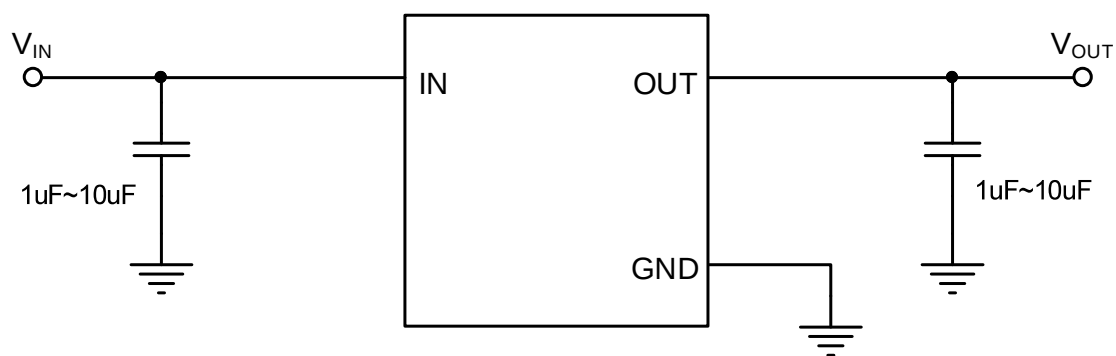
Load Transient Response
 $V_{IN}=5.3V$, $V_{OUT}=3.3V$, $I_{OUT}=1mA\sim 100mA$

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Application Circuits



With EN function

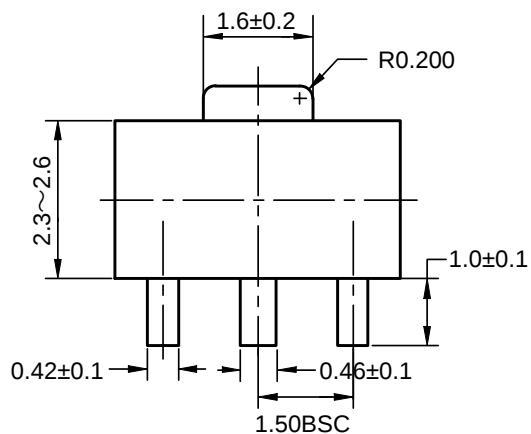


Without EN function

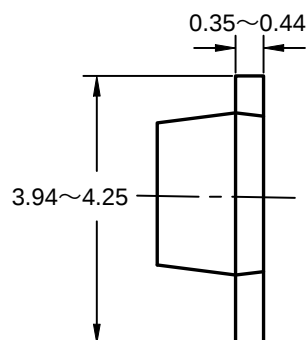
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Package Dimension

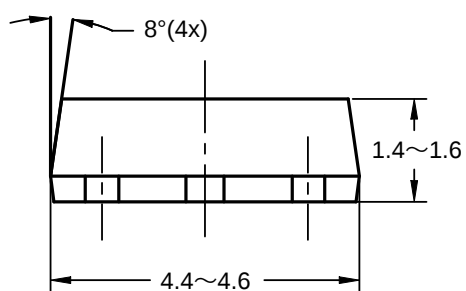
SOT89-3



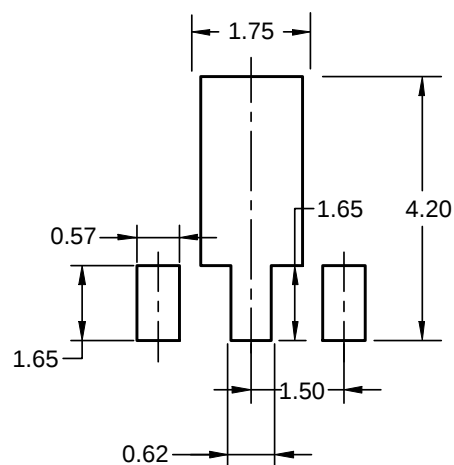
Top View



Side View



Side View

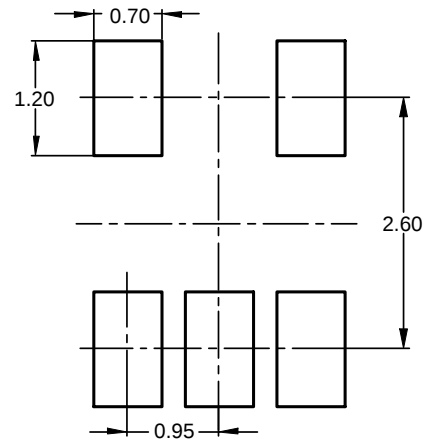
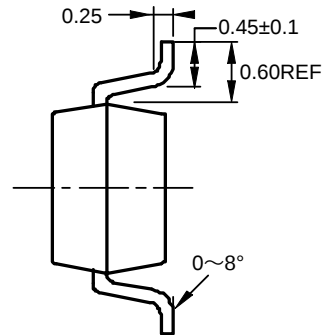
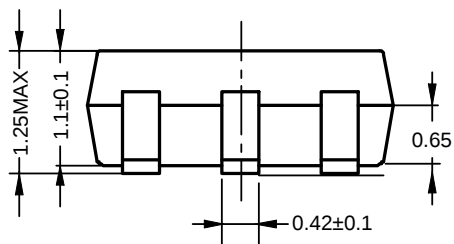
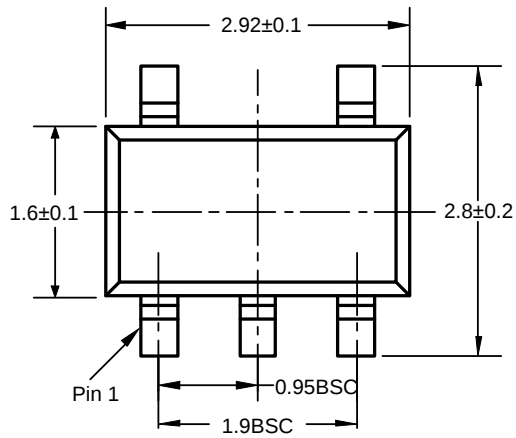


Recommended Land Pattern

Unit: mm

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SOT23-5

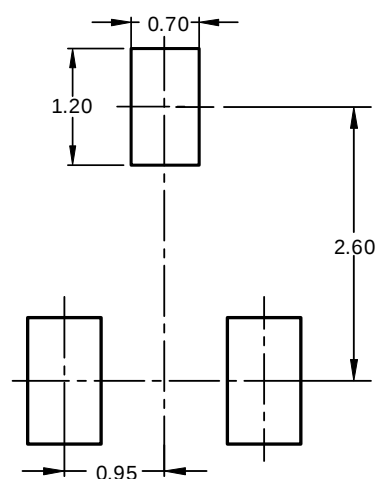
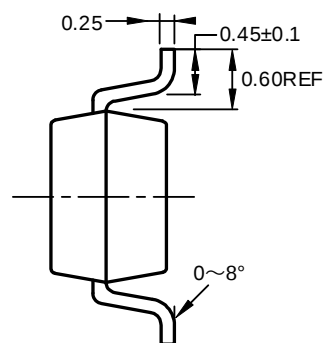
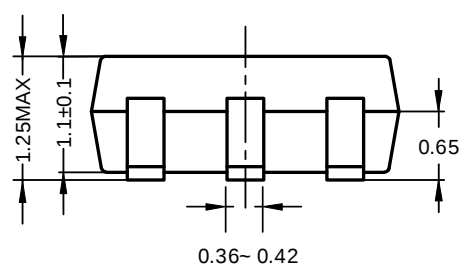
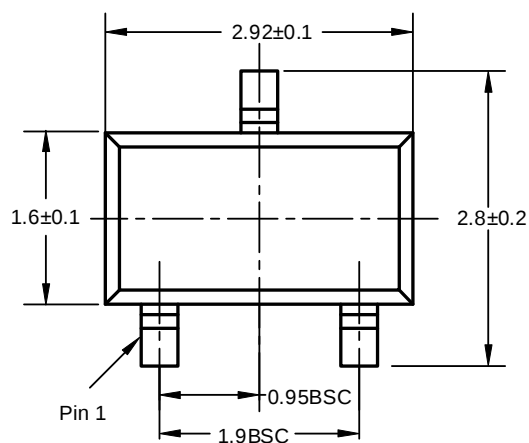


Recommended Land Pattern

Unit: mm

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SOT23-3

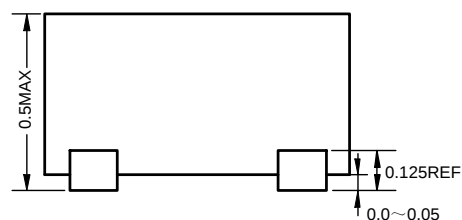
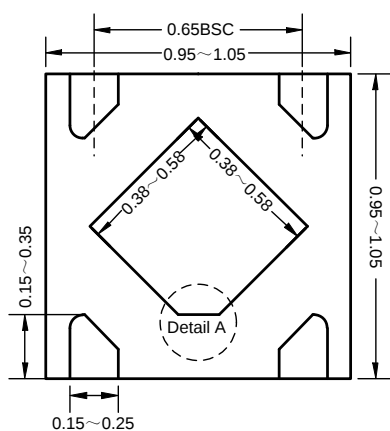


Recommended Land Pattern

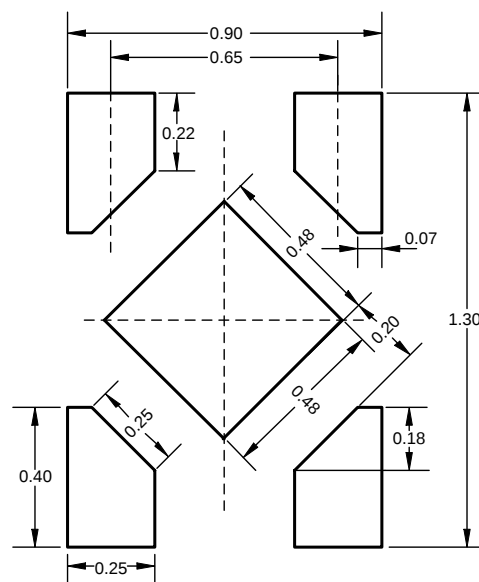
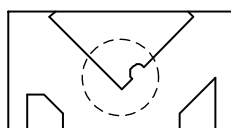
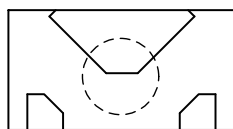
Unit: mm

ET6H3XX

DFN4(1x1)



Detail A: (PIN1 shape)



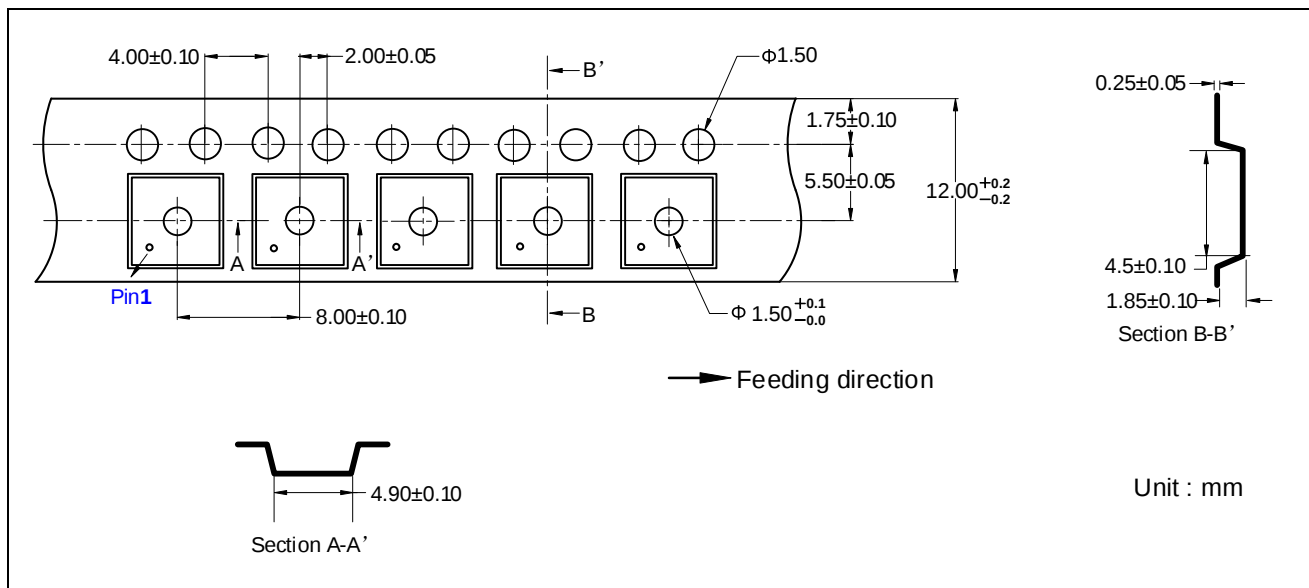
Recommended Land Pattern

Unit: mm

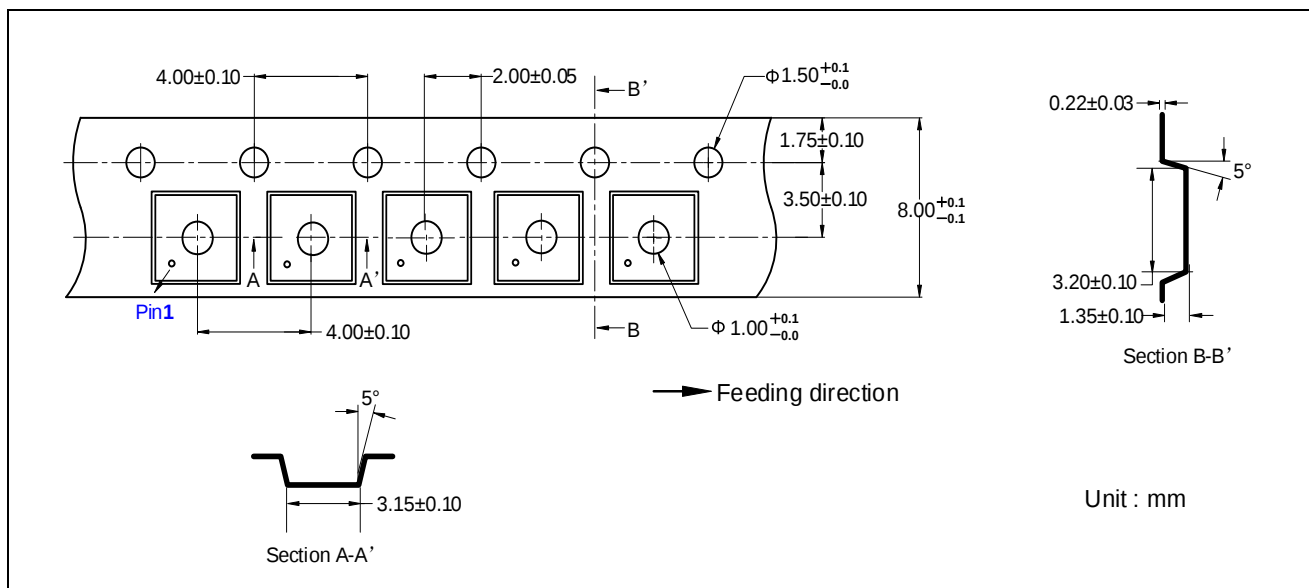
ET6H3XX

Tape Information

SOT89-3

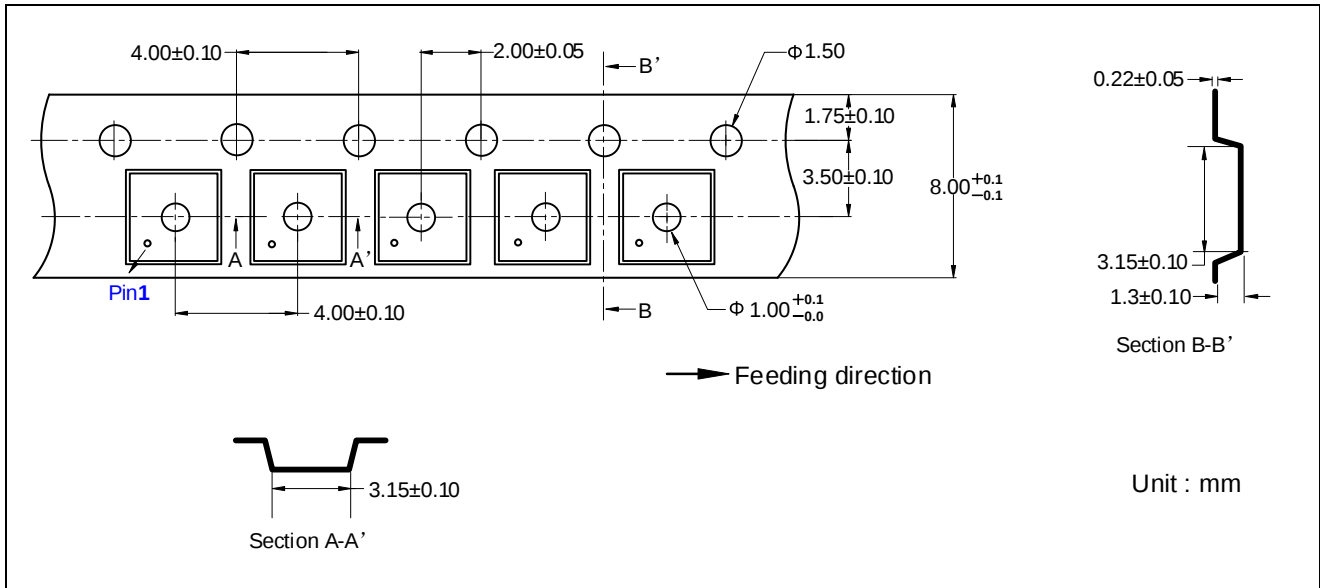


SOT23-3

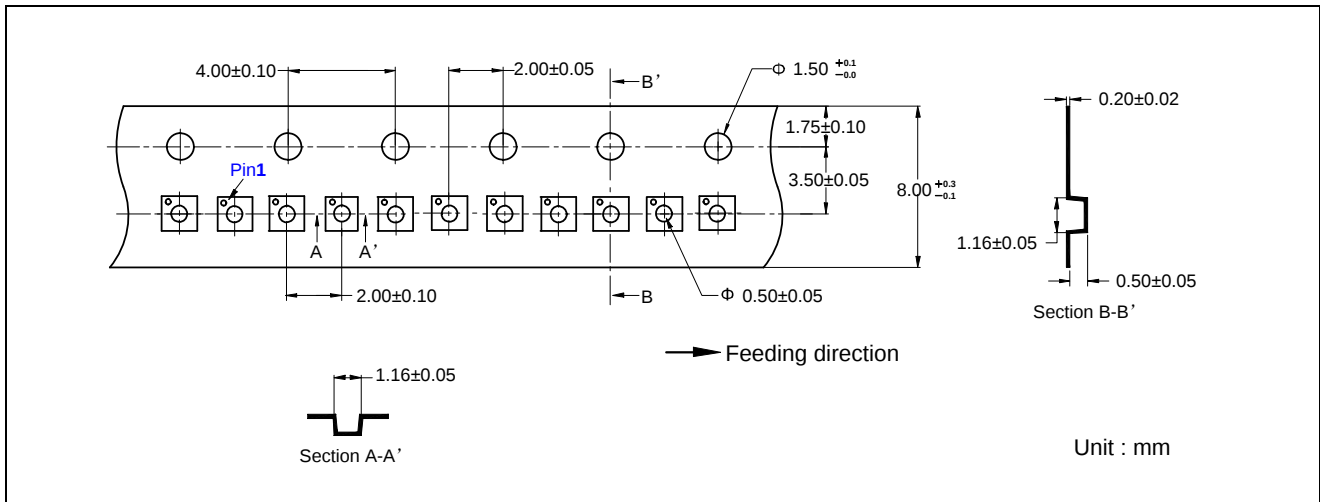


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SOT23-5



DFN4



Revision History and Checking Table

Version	Date	Revision Item	Modifier	Function & Spec Checking	Package & Tape Checking
0.0	2022-3-21	Preliminary Version	Liuxm	Liuxm	Liujy
1.0	2022-8-5	Official Version	Shi Bo	Liuxm	Zhuji
1.1	2023-10-7	Update package	Shibo	Shibo	Shibo
1.2	2025-5-26	Update package	Pengjj	Shibo	Shibo